

Single N-channel MOSFET

ELM16402EA-S

■ General description

ELM16402EA-S uses advanced trench technology to provide excellent $R_{ds(on)}$, low gate charge and low gate resistance.

■ Features

- $V_{ds}=30V$
- $I_d=6.9A$ ($V_{gs}=10V$)
- $R_{ds(on)} < 28m\Omega$ ($V_{gs}=10V$)
- $R_{ds(on)} < 42m\Omega$ ($V_{gs}=4.5V$)

■ Maximum absolute ratings

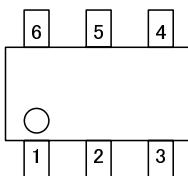
Parameter	Symbol	Limit	Unit	Note
Drain-source voltage	V_{ds}	30	V	
Gate-source voltage	V_{gs}	± 20	V	
Continuous drain current	I_d	6.9	A	1
		5.8		
Pulsed drain current	I_{dm}	20	A	2
Power dissipation	P_d	2.00	W	
		1.44		
Junction and storage temperature range	T_j, T_{stg}	-55 to 150	°C	

■ Thermal characteristics

Parameter		Symbol	Typ.	Max.	Unit	Note
Maximum junction-to-ambient	$t \leq 10s$	$R_{\theta ja}$	48.0	62.5	°C/W	1
Maximum junction-to-ambient	Steady-state		74.0	110.0	°C/W	
Maximum junction-to-lead	Steady-state	$R_{\theta jl}$	35.0	40.0	°C/W	3

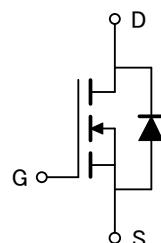
■ Pin configuration

SOT-26 (TOP VIEW)



Pin No.	Pin name
1	DRAIN
2	DRAIN
3	GATE
4	SOURCE
5	DRAIN
6	DRAIN

■ Circuit



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■ Electrical characteristics

T_a=25°C

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
STATIC PARAMETERS						
Drain-source breakdown voltage	BVdss	Id=250 μA, Vgs=0V	30			V
Zero gate voltage drain current	Idss	Vds=24V			1	μ A
		Vgs=0V	T _j =55°C		5	
Gate-body leakage current	Igss	Vds=0V, Vgs=±20V			100	nA
Gate threshold voltage	Vgs(th)	Vds=Vgs, Id=250 μ A	1.0	1.9	3.0	V
On state drain current	Id(on)	Vgs=4.5V, Vds=5V	20			A
Static drain-source on-resistance	Rds(on)	Vgs=10V		22.5	28.0	m Ω
		Id=6.9A	T _j =125°C	31.3	38.0	
		Vgs=4.5V, Id=5.0A		34.5	42.0	
Forward transconductance	Gfs	Vds=5V, Id=6.9A	10.0	15.4		S
Diode forward voltage	Vsd	Is=1A		0.76	1.00	V
Max. body-diode continuous current	Is				3	A
DYNAMIC PARAMETERS						
Input capacitance	Ciss	Vgs=0V, Vds=15V, f=1MHz		680	820	pF
Output capacitance	Coss			102		pF
Reverse transfer capacitance	Crss			77		pF
Gate resistance	Rg	Vgs=0V, Vds=0V, f=1MHz		3.0	3.6	Ω
SWITCHING PARAMETERS						
Total gate charge (10V)	Qg	Vgs=10V, Vds=15V, Id=6.9A		13.84	16.70	nC
Total gate charge (4.5V)	Qg			6.74	8.10	nC
Gate-source charge	Qgs			1.82		nC
Gate-drain charge	Qgd			3.20		nC
Turn-on delay time	td(on)	Vgs=10V, Vds=15V R _l =2.2 Ω, R _{gen} =3 Ω		4.6		ns
Turn-on rise time	tr			4.1		ns
Turn-off delay time	td(off)			20.6		ns
Turn-off fall time	tf			5.2		ns
Body diode reverse recovery time	trr	I _f =6.9A, dI/dt=100A/μ s		16.5	20.0	ns
Body diode reverse recovery charge	Qrr	I _f =6.9A, dI/dt=100A/μ s		7.8		nC

NOTE :

- The value of R_{θja} is measured with the device mounted on 1in² FR-4 board of 2oz. Copper, in still air environment with T_a=25°C. The value in any given applications depends on the user's specific board design, The current rating is based on the t ≤ 10s thermal resistance rating.
- Repetitive rating, pulse width limited by junction temperature.
- The R_{θja} is the sum of the thermal impedance from junction to lead R_{θjl} and lead to ambient.
- The static characteristics in Figures 1 to 6 are obtained using 80μs pulses, duty cycle 0.5%max.
- These tests are performed with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with T_a=25°C. The SOA curve provides a single pulse rating.



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■ Typical electrical and thermal characteristics

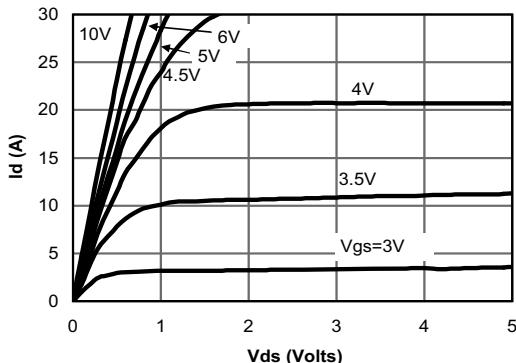


Fig 1: On-Region Characteristics

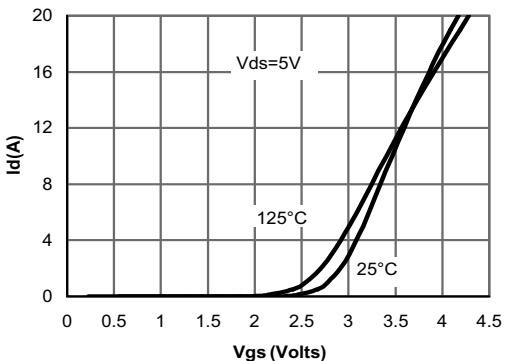


Figure 2: Transfer Characteristics

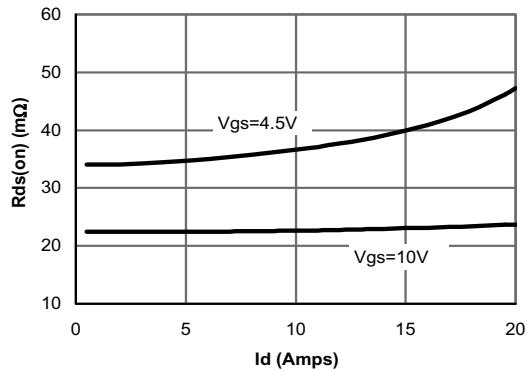


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

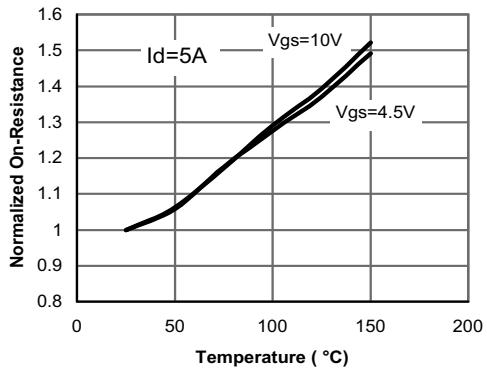


Figure 4: On-Resistance vs. Junction Temperature

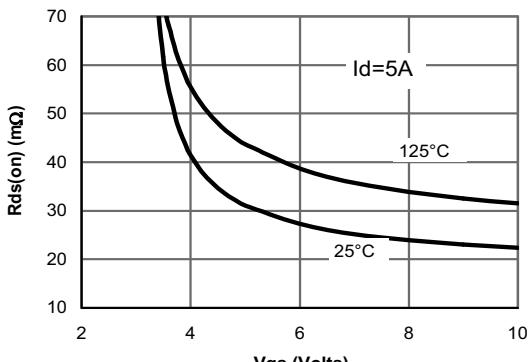


Figure 5: On-Resistance vs. Gate-Source Voltage

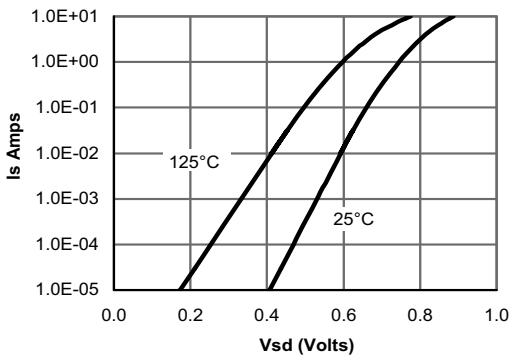


Figure 6: Body diode characteristics

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